

N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
	11mΩ @ V _{GS} = 10V	10.5A
30V	15mΩ @ V _{GS} = 4.5V	9.2A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- Power Management Functions
- DC-DC Converters

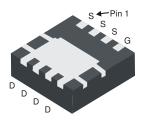
Features and Benefits

- Low RDS(ON) Ensures On State Losses Are Minimized
- Small Form Factor Thermally Efficient Package Enables Higher Density End Products
- Occupies Just 33% of The Board Area Occupied by SO-8 Enabling Smaller End Product
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part is Available Under Separate Datasheet (DMG7430LFGQ)

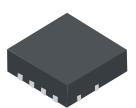
Mechanical Data

- Case: PowerDI[®]3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (24)
- Weight: 0.072 grams (Approximate)

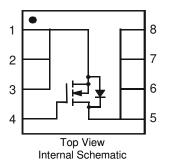
PowerDI3333-8







Top View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMG7430LFG-7	PowerDI3333-8	2000/Tape & Reel
DMG7430LFG-13	PowerDI3333-8	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

Site1



G73 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 21 = 2021) WW = Week Code (01 to 53)

Site 2



G73 = Product Type Marking Code
YWX = Date Code Marking
Y = Year (ex: 1 = 2021)
W = Week (ex: A = Week 27; Z Represents Week 52 And 53)
X = Internal Code (ex: U = Monday)

Date Code Key

Year	2011	 2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	1	 1	2	3	4	5	6	7	8	9	0

Week	1-26	27-52	53
Code	A-Z	a-z	z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	T	U	V	W	X	Υ	Z

Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Steady Tr			lο	10.5 8.5	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	ΙD	14 11	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	s)		I _{DM}	90	Α
Maximum Continuous Body Diode Forward Current	ls	3.0	Α		
Avalanche Current (Note 7) L = 0.1mH	lar	22	Α		
Repetitive Avalanche Energy (Note 7) L = 0.1mH			Ear	24	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

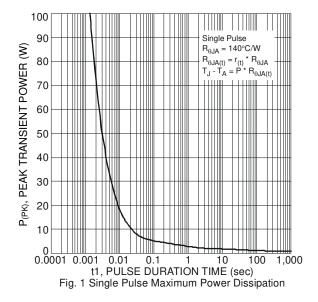
Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	Steady State	Pp	0.9	W	
Total Fower Dissipation (Note 5)	t<10s		1.5	٧٧	
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Б.	142	°C/W	
Thermal nesistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	78	C/VV	
Total Dawer Dissipation (Note 6)	Steady State	PD	2.2	W	
Total Power Dissipation (Note 6)	t<10s	PD	3.5		
Thermal Decistance Junction to Ambient (Note C)	Steady State		59	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	33		
Thermal Resistance, Junction to Case (Note 6)	R _θ JC	11			
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C	

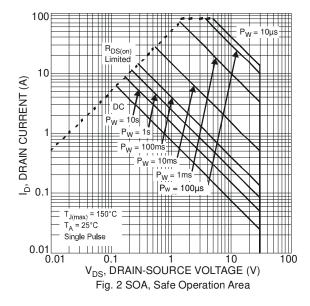
Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

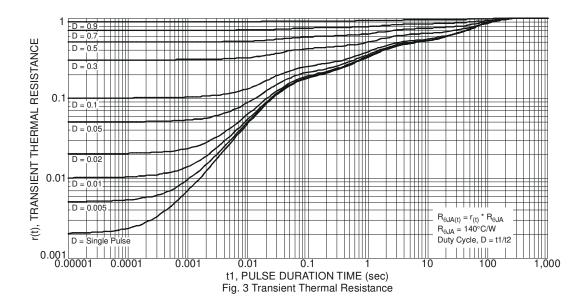
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

^{7.} I_{AR} and E_{AR} ratings are based on low frequency and duty cycles to keep $T_{J} = +25$ °C.











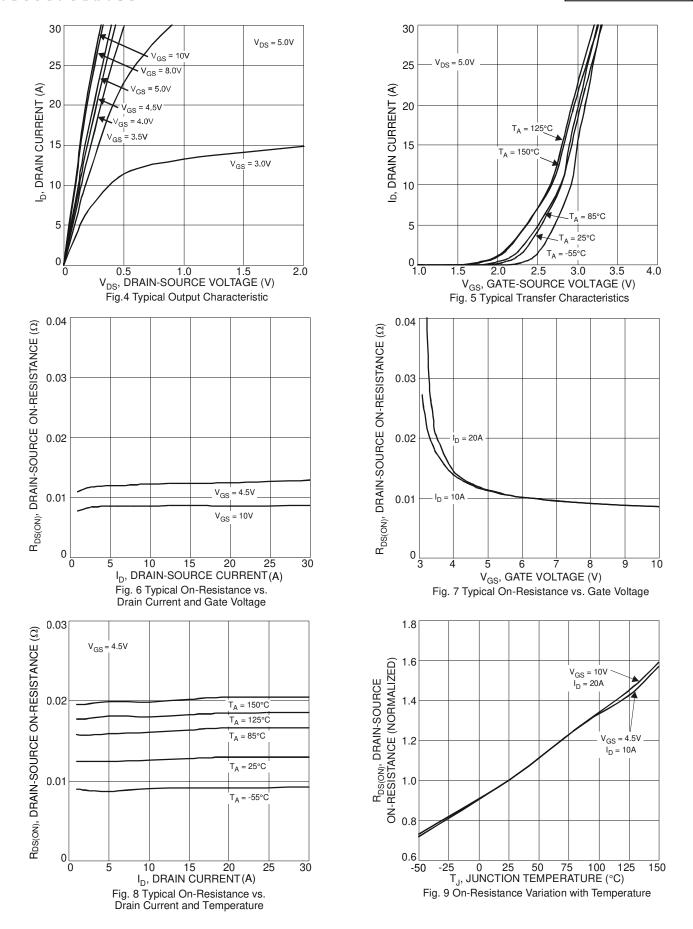
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BVDSS	30	_		V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 30V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS} (TH)	1.4	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance	Provens	_	7	11	mΩ	VGS = 10V, ID = 20A
Static Drain-Source On-nesistance	RDS(ON)	_	11	15	1117.7	$V_{GS} = 4.5V, I_{D} = 20A$
Forward Transfer Admittance	Y _{fs}	_	74	_	S	$V_{DS} = 5V, I_{D} = 20A$
Diode Forward Voltage	VsD	_	0.75	1.0	V	$V_{GS} = 0V$, $I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	Ciss	_	1281	_	pF	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Output Capacitance	Coss	_	145	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	125	_	pF	1 = 1.000112
Gate Resistance	Rg	_	1.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$
Total Gate Charge (VGS = 4.5V)	Qg	_	12.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	26.7	_	nC	15// 10/
Gate-Source Charge	Qgs	_	3.6	_	nC	$V_{DS} = 15V, I_D = 12A$
Gate-Drain Charge	Qgd	_	4.4	_	nC	1
Turn-On Delay Time	td(ON)	_	5.2	_	ns	
Turn-On Rise Time	tr	_	21.2	_	ns	V _{DD} = 15V, V _{GS} = 10V,
Turn-Off Delay Time	t _{D(OFF)}	_	22.3	_	ns	$R_L = 1.25\Omega$, $R_G = 3\Omega$
Turn-Off Fall Time	tF	_	5.1	_	ns	1
Reverse Recovery Time	trr	_	8.5	_	ns	IF = 12A, di/dt = 500A/µs
Reverse Recovery Charge	Q _{RR}	_	7.0		nC	I _F = 12A, di/dt = 500A/μs

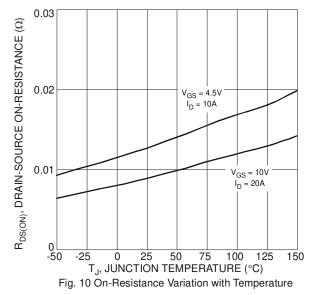
Notes:

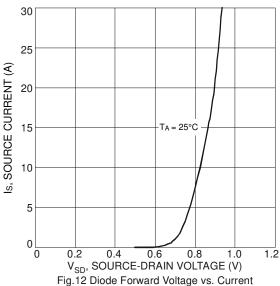
^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.

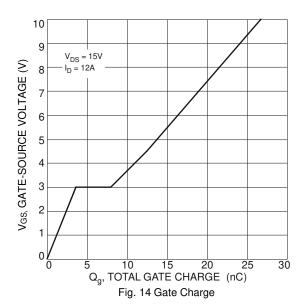


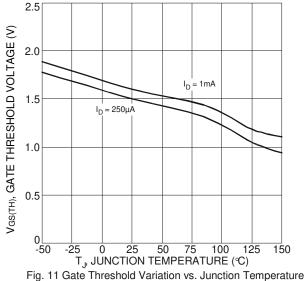


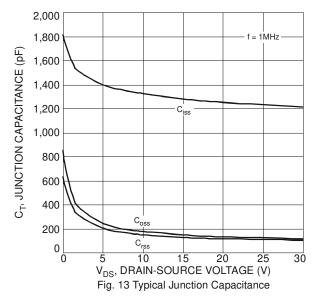










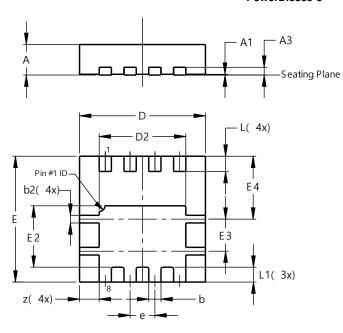




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8

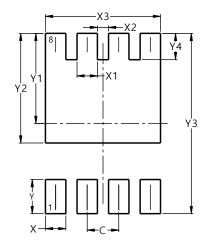


	PowerDI3333-8								
Dim	Min	Max	Тур						
Α	0.75	0.85	0.80						
A1	0.00	0.05	0.02						
A3	_	_	0.203						
b	0.27	0.37	0.32						
b2	0.15	0.25	0.20						
D	3.25	3.35	3.30						
D2	2.22	2.32	2.27						
E	3.25	3.35	3.30						
E2	1.56	1.66	1.61						
E 3	0.79	0.89	0.84						
E4	1.60	1.70	1.65						
е	_	_	0.65						
L	0.35	0.45	0.40						
L1	_	_	0.39						
Z	_	_	0.515						
All I	Dimens	sions ir	n mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Υ	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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